

SCAN18541T

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SCAN18541T Non-Inverting Line Driver with TRI-STATE® Outputs

Check for Samples: SCAN18541T

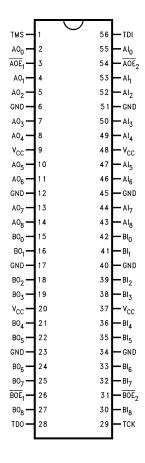
FEATURES

- IEEE 1149.1 (JTAG) Compliant
- Dual output enable signals per byte
- TRI-STATE outputs for bus-oriented applications
- 9-bit data busses for parity applications
- Reduced-swing outputs source 24 mA/sink 48 mA (Mil)
- Guaranteed to drive 50Ω transmission line to TTL input levels of 0.8V and 2.0V
- TTL compatible inputs
- 25 mil pitch Cerpack packaging
- Includes CLAMP and HIGHZ instructions
- Standard Microcircuit Drawing (SMD) 5962-9311601

DESCRIPTION

The SCAN18541T is a high speed, low-power line driver featuring separate data inputs organized into dual 9-bit bytes with byte-oriented paired output enable control signals. This device is compliant with IEEE 1149.1 Standard Test Access Port and Boundary Scan Architecture with the incorporation of the defined boundary-scan test logic and test access port consisting of Test Data Input (TDI), Test Data Out (TDO), Test Mode Select (TMS), and Test Clock (TCK).

CONNECTION DIAGRAM



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Pin Names

| Pin Names | Description |
|---|--|
| AI ₍₀₋₈₎ | Input Pins, A Side |
| BI ₍₀₋₈₎ | Input Pins, B Side |
| \overline{AOE}_1 , \overline{AOE}_2 | TRI-STATE Output Enable Input Pins, A Side |
| \overline{BOE}_1 , \overline{BOE}_2 | TRI-STATE Output Enable Input Pins, B Side |
| AO ₍₀₋₈₎ | Output Pins, A Side |
| AO ₍₀₋₈₎ | Output Pins, B Side |

Truth Table

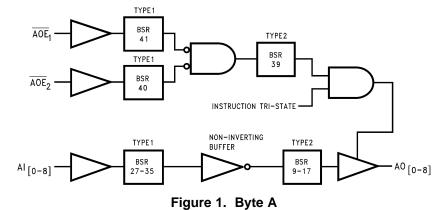
| | Inputs | | AO (0–8) |
|------------------|------------------|----------|----------|
| AOE ₁ | AOE ₂ | AI (0-8) | |
| L | L | Н | Н |
| Н | Х | X | Z |
| X | Н | X | Z |
| L | L | L | L |

(1) H= HIGH Voltage Level L= LOW Voltage Level

X= Immaterial
Z= High Impedance

| | Inputs | | BO (0-8) |
|------------------|------------------|----------|----------|
| BOE ₁ | BOE ₂ | BI (0-8) | |
| L | L | Н | Н |
| Н | X | X | Z |
| X | Н | X | Z |
| L | L | L | L |

Block Diagram



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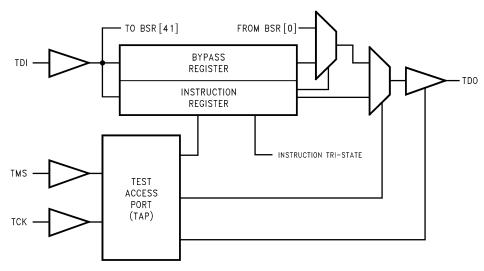
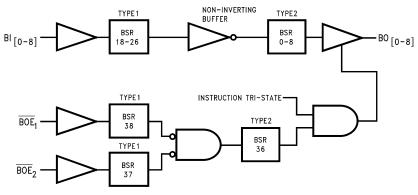


Figure 2. Tap Controller



Note: BSR stands for Boundary Scan Register.

Figure 3. Byte B

Description of Boundary-Scan Circuitry

The scan cells used in the BOUNDARY-SCAN register are one of the following two types depending upon their location. Scan cell TYPE1 is intended to solely observe system data, while TYPE2 has the additional ability to control system data. (See IEEE Standard 1149.1 *Figure 10–11* for a further description of scan cell TYPE1 and *Figure 10–12* for a further description of scan cell TYPE2.)

Scan cell TYPE1 is located on each system input pin while scan cell TYPE2 is located at each system output pin as well as at each of the two internal active-high output enable signals. AOE controls the activity of the A-outputs while BOE controls the activity of the B-outputs. Each will activate their respective outputs by loading a logic high.

The BYPASS register is a single bit shift register stage identical to scan cell TYPE1. It captures a fixed logic low.



Figure 4. Bypass Register Scan Chain Definition Logic 0



The INSTRUCTION register is an 8-bit register which captures the default value of 10000001. The two least significant bits of this captured value (01) are required by IEEE Std 1149.1. The upper six bits are unique to the SCAN18541T device. SCAN CMOS Test Access Logic devices do not include the IEEE 1149.1 optional identification register. Therefore, this unique captured value can be used as a "pseudo ID" code to confirm that the correct device is placed in the appropriate location in the boundary scan chain.

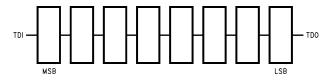


Figure 5. Instruction Register Scan Chain Definition

 $MSB \rightarrow LSB$ (1)

| Instruction Code | Instruction |
|------------------|----------------|
| 0000000 | EXTEST |
| 10000001 | SAMPLE/PRELOAD |
| 10000010 | CLAMP |
| 0000011 | HIGH-Z |
| All Others | BYPASS |

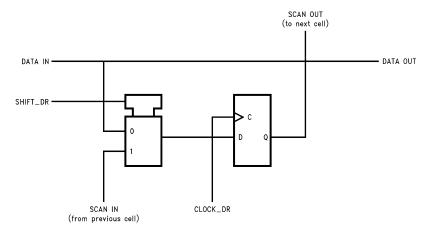


Figure 6. Scan Cell TYPE 1

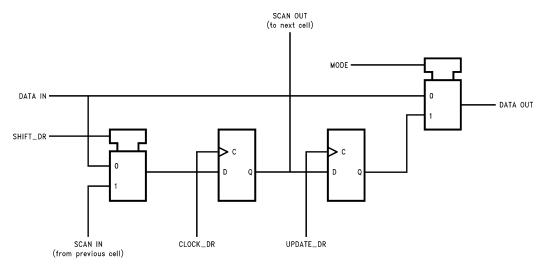


Figure 7. Scan Cell TYPE2

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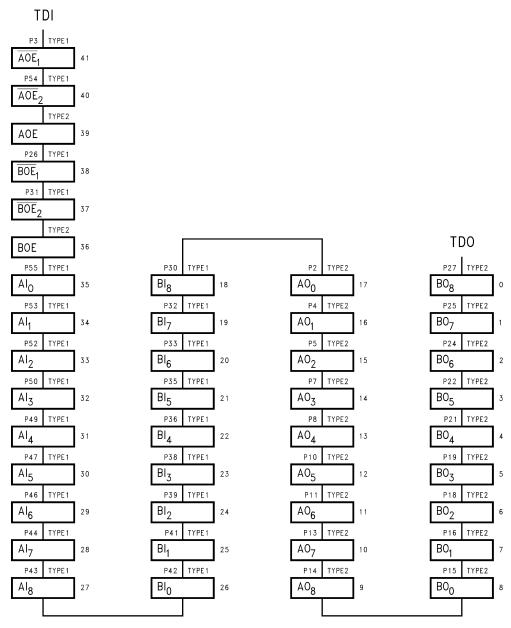


Figure 8. Boundary-Scan Register Scan Chain Definition (42 Bits in Length)

Boundary-Scan Register Definition Index

(2)

| Bit No. | Pin Name | Pin No. | Pin Type | Scan Cell | Туре |
|---------|------------------|---------|----------|-----------|---------|
| 41 | AOE₁ | 3 | Input | TYPE1 | Control |
| 40 | AOE ₂ | 54 | Input | TYPE1 | Signals |
| 39 | AOE | | Internal | TYPE2 | |
| 38 | BOE ₁ | 26 | Input | TYPE1 | |
| 37 | BOE ₂ | 31 | Input | TYPE1 | |
| 36 | BOE | | Internal | TYPE2 | |



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| 35 | Bit No. | Pin Name | Pin No. | Pin Type | Scan Cell | Туре |
|--|---------|-----------------|---------|----------|-----------|-------|
| 33 | 35 | Al ₀ | 55 | Input | TYPE1 | A–in |
| 32 | 34 | Al ₁ | 53 | Input | TYPE1 | |
| 31 | 33 | Al ₂ | 52 | Input | TYPE1 | |
| 30 | 32 | Al ₃ | 50 | Input | TYPE1 | |
| 29 | 31 | Al ₄ | 49 | Input | TYPE1 | |
| 28 | 30 | Al ₅ | 47 | Input | TYPE1 | |
| 27 | 29 | Al ₆ | 46 | Input | TYPE1 | |
| 26 Bl ₀ 42 Input TYPE1 B-in 25 Bl ₁ 41 Input TYPE1 24 Bl ₂ 39 Input TYPE1 23 Bl ₃ 38 Input TYPE1 22 Bl ₄ 36 Input TYPE1 21 Bl ₅ 35 Input TYPE1 20 Bl ₆ 33 Input TYPE1 19 Bl ₇ 32 Input TYPE1 18 Bl ₈ 30 Input TYPE1 17 AO ₀ 2 Output TYPE2 16 AO ₁ 4 Output TYPE2 15 AO ₂ 5 Output TYPE2 14 AO ₃ 7 Output TYPE2 13 AO ₄ 8 Output TYPE2 11 AO ₆ 11 Output TYPE2 11 AO ₈ 14 Output | 28 | Al ₇ | 44 | Input | TYPE1 | |
| 25 | 27 | Al ₈ | 43 | Input | TYPE1 | |
| 24 | 26 | BI ₀ | 42 | Input | TYPE1 | B–in |
| 23 | 25 | BI ₁ | 41 | Input | TYPE1 | |
| 22 | 24 | Bl ₂ | 39 | Input | TYPE1 | |
| 21 | 23 | Bl_3 | 38 | Input | TYPE1 | |
| Big | 22 | BI ₄ | 36 | Input | TYPE1 | |
| 19 | 21 | BI ₅ | 35 | Input | TYPE1 | |
| 18 | 20 | BI ₆ | 33 | Input | TYPE1 | |
| 17 | 19 | BI ₇ | 32 | Input | TYPE1 | |
| 16 AO1 4 Output TYPE2 15 AO2 5 Output TYPE2 14 AO3 7 Output TYPE2 13 AO4 8 Output TYPE2 12 AO5 10 Output TYPE2 11 AO6 11 Output TYPE2 10 AO7 13 Output TYPE2 9 AO8 14 Output TYPE2 8 BO0 15 Output TYPE2 8 BO0 15 Output TYPE2 6 BO2 18 Output TYPE2 5 BO3 19 Output TYPE2 4 BO4 21 Output TYPE2 4 BO4 21 Output TYPE2 3 BO6 22 Output TYPE2 1 BO7 25 Output TYPE2 | 18 | BI ₈ | 30 | Input | TYPE1 | |
| 15 AO2 5 Output TYPE2 14 AO3 7 Output TYPE2 13 AO4 8 Output TYPE2 12 AO5 10 Output TYPE2 11 AO6 11 Output TYPE2 10 AO7 13 Output TYPE2 9 AO8 14 Output TYPE2 8 BO0 15 Output TYPE2 8 BO1 16 Output TYPE2 6 BO2 18 Output TYPE2 5 BO3 19 Output TYPE2 4 BO4 21 Output TYPE2 3 BO5 22 Output TYPE2 2 BO6 24 Output TYPE2 1 BO7 25 Output TYPE2 | 17 | AO ₀ | 2 | Output | TYPE2 | A-out |
| 14 AO3 7 Output TYPE2 13 AO4 8 Output TYPE2 12 AO5 10 Output TYPE2 11 AO6 11 Output TYPE2 10 AO7 13 Output TYPE2 9 AO8 14 Output TYPE2 8 BO0 15 Output TYPE2 8 BO1 16 Output TYPE2 6 BO2 18 Output TYPE2 5 BO3 19 Output TYPE2 4 BO4 21 Output TYPE2 3 BO5 22 Output TYPE2 2 BO6 24 Output TYPE2 1 BO7 25 Output TYPE2 | 16 | AO ₁ | 4 | Output | TYPE2 | |
| 13 AO ₄ 8 Output TYPE2 12 AO ₅ 10 Output TYPE2 11 AO ₆ 11 Output TYPE2 10 AO ₇ 13 Output TYPE2 9 AO ₈ 14 Output TYPE2 8 BO ₀ 15 Output TYPE2 7 BO ₁ 16 Output TYPE2 6 BO ₂ 18 Output TYPE2 5 BO ₃ 19 Output TYPE2 4 BO ₄ 21 Output TYPE2 3 BO ₅ 22 Output TYPE2 2 BO ₆ 24 Output TYPE2 1 BO ₇ 25 Output TYPE2 | 15 | AO ₂ | 5 | Output | TYPE2 | |
| 12 AO ₅ 10 Output TYPE2 11 AO ₆ 11 Output TYPE2 10 AO ₇ 13 Output TYPE2 9 AO ₈ 14 Output TYPE2 8 BO ₀ 15 Output TYPE2 7 BO ₁ 16 Output TYPE2 6 BO ₂ 18 Output TYPE2 5 BO ₃ 19 Output TYPE2 4 BO ₄ 21 Output TYPE2 3 BO ₅ 22 Output TYPE2 2 BO ₆ 24 Output TYPE2 1 BO ₇ 25 Output TYPE2 | 14 | AO ₃ | 7 | Output | TYPE2 | |
| 11 AO ₆ 11 Output TYPE2 10 AO ₇ 13 Output TYPE2 9 AO ₈ 14 Output TYPE2 8 BO ₀ 15 Output TYPE2 7 BO ₁ 16 Output TYPE2 6 BO ₂ 18 Output TYPE2 5 BO ₃ 19 Output TYPE2 4 BO ₄ 21 Output TYPE2 3 BO ₅ 22 Output TYPE2 2 BO ₆ 24 Output TYPE2 1 BO ₇ 25 Output TYPE2 | 13 | AO ₄ | 8 | Output | TYPE2 | |
| 10 AO ₇ 13 Output TYPE2 9 AO ₈ 14 Output TYPE2 8 BO ₀ 15 Output TYPE2 B-out 7 BO ₁ 16 Output TYPE2 6 BO ₂ 18 Output TYPE2 5 BO ₃ 19 Output TYPE2 4 BO ₄ 21 Output TYPE2 3 BO ₅ 22 Output TYPE2 2 BO ₆ 24 Output TYPE2 1 BO ₇ 25 Output TYPE2 | 12 | AO ₅ | 10 | Output | TYPE2 | |
| 9 AO ₈ 14 Output TYPE2 8 BO ₀ 15 Output TYPE2 7 BO ₁ 16 Output TYPE2 6 BO ₂ 18 Output TYPE2 5 BO ₃ 19 Output TYPE2 4 BO ₄ 21 Output TYPE2 3 BO ₅ 22 Output TYPE2 2 BO ₆ 24 Output TYPE2 1 BO ₇ 25 Output TYPE2 | 11 | AO ₆ | 11 | Output | TYPE2 | |
| 8 BO ₀ 15 Output TYPE2 B-out 7 BO ₁ 16 Output TYPE2 6 BO ₂ 18 Output TYPE2 5 BO ₃ 19 Output TYPE2 4 BO ₄ 21 Output TYPE2 3 BO ₅ 22 Output TYPE2 2 BO ₆ 24 Output TYPE2 1 BO ₇ 25 Output TYPE2 | 10 | AO ₇ | 13 | Output | TYPE2 | |
| 7 BO ₁ 16 Output TYPE2 6 BO ₂ 18 Output TYPE2 5 BO ₃ 19 Output TYPE2 4 BO ₄ 21 Output TYPE2 3 BO ₅ 22 Output TYPE2 2 BO ₆ 24 Output TYPE2 1 BO ₇ 25 Output TYPE2 | 9 | AO ₈ | 14 | Output | TYPE2 | |
| 6 BO2 18 Output TYPE2 5 BO3 19 Output TYPE2 4 BO4 21 Output TYPE2 3 BO5 22 Output TYPE2 2 BO6 24 Output TYPE2 1 BO7 25 Output TYPE2 | 8 | BO ₀ | 15 | Output | TYPE2 | B-out |
| 5 BO ₃ 19 Output TYPE2 4 BO ₄ 21 Output TYPE2 3 BO ₅ 22 Output TYPE2 2 BO ₆ 24 Output TYPE2 1 BO ₇ 25 Output TYPE2 | 7 | BO ₁ | 16 | Output | TYPE2 | |
| 4 BO ₄ 21 Output TYPE2 3 BO ₅ 22 Output TYPE2 2 BO ₆ 24 Output TYPE2 1 BO ₇ 25 Output TYPE2 | 6 | BO ₂ | 18 | Output | TYPE2 | |
| 3 BO ₅ 22 Output TYPE2 2 BO ₆ 24 Output TYPE2 1 BO ₇ 25 Output TYPE2 | 5 | BO ₃ | 19 | Output | TYPE2 | |
| 2 BO ₆ 24 Output TYPE2 1 BO ₇ 25 Output TYPE2 | 4 | BO ₄ | 21 | Output | TYPE2 | |
| 1 BO ₇ 25 Output TYPE2 | 3 | BO ₅ | 22 | Output | TYPE2 | |
| | 2 | BO ₆ | 24 | Output | TYPE2 | |
| 0 BO ₈ 27 Output TYPE2 | 1 | BO ₇ | 25 | Output | TYPE2 | |
| | 0 | BO ₈ | 27 | Output | TYPE2 | |



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

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Absolute Maximum Ratings (1)

| Supply Voltage (V _{CC}) | -0.5V to +7.0V |
|---|--------------------------------|
| DC Input Diode Current (I _{IK}) | |
| $V_{I} = -0.5V$ | −20 mA |
| $V_{I} = V_{CC} + 0.5V$ | +20 mA |
| DC Output Diode Current (I _{OK}) | |
| $V_{O} = -0.5V$ | −20 mA |
| $V_O = V_{CC} + 0.5V$ | +20 mA |
| DC Output Voltage (V _O) | -0.5V to V _{CC} +0.5V |
| DC Output Source/Sink Current (I _O) | ±70 mA |
| DC V _{CC} or Ground Current | |
| Per Output Pin | ±70 mA |
| Junction Temperature | |
| Cerpack | +175°C |
| Storage Temperature | −65°C to +150°C |
| ESD (Min) | 2000V |

⁽¹⁾ Absolute maximum ratings are those values beyond which damage to the device may occur. The databook specifications should be met, without exception, to ensure that the system design is reliable over its power supply, temperature, and output/input loading variables. National does not recommend operation of SCAN circuits outside databook specifications.

Recommended Operating Conditions

| 4.5V to 5.5V |
|-----------------------|
| 0V to V _{CC} |
| 0V to V _{CC} |
| |
| −55°C to +125°C |
| 125 mV/ns |
| |
| |
| |

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DC Electrical Characteristics

| Symbol | Parameter | V _{CC} | Military | Units | Conditions |
|------------------|-------------------------|-----------------|----------------------------------|-------|------------------------------------|
| | | (V) | T _A = −55°C to +125°C | | |
| | | | Guaranteed Limits | | |
| V _{IH} | Minimum High | 4.5 | 2.0 | V | V _{OUT} = 0.1V |
| | Input Voltage | 5.5 | 2.0 | | or V _{CC} -0.1V |
| V _{IL} | Maximum Low | 4.5 | 0.8 | V | V _{OUT} = 0.1V |
| | Input Voltage | 5.5 | 0.8 | | or V _{CC} -0.1V |
| V _{OH} | Minimum High | 4.5 | 3.15 | V | I _{OUT} = -50 μA |
| | Output Voltage | 5.5 | 4.15 | | |
| | | 4.5 | 2.4 | V | $V_{IN} = V_{IL}$ or V_{IH} |
| | | 5.5 | 2.4 | | I _{OH} = −24 mA |
| V _{OL} | Maximum Low | 4.5 | 0.1 | V | I _{OUT} = 50 μA |
| | Output Voltage | 5.5 | 0.1 | | |
| | | 4.5 | 0.55 | V | $V_{IN} = V_{IL}$ or V_{IH} |
| | | 5.5 | 0.55 | | I _{OL} = 48 mA |
| I _{IN} | Maximum Input | 5.5 | ±1.0 | μA | $V_I = V_{CC}$, GND |
| | Leakage Current | | | | |
| I _{IN} | Maximum Input | 5.5 | 3.7 | μA | $V_I = V_{CC}$ |
| TDI, TMS | Leakage | | -385 | μA | V _I = GND |
| | Minimum Input | 5.5 | -160 | μA | V _I = GND |
| | Leakage | | | | |
| I _{OLD} | Minimum Dynamic | 5.5 | 63 | mA | V _{OLD} = 0.8V Max |
| I _{OHD} | Output Current | | - 27 | mA | V _{OHD} = 2.0V Min |
| l _{OZ} | Maximum Output | 5.5 | ±10.0 | μA | V_{I} (OE) = V_{IL} , V_{IH} |
| | Leakage Current | | | | |
| I _{OS} | Output Short | 5.5 | -100 | mA | V _O = 0V |
| | Circuit Current | | | (min) | |
| Icc | Maximum Quiescent | 5.5 | 168 | μA | V _O = Open |
| | Supply Current | | | | TDI, TMS = V _{CC} |
| | | 5.5 | 930 | μA | V _O = Open |
| | | | | | TDI, TMS = GND |
| I _{CCt} | Maximum I _{CC} | 5.5 | 2.0 | mA | $V_I = V_{CC}-2.1V$ |
| | Per Input | 5.5 | 2.15 | | $V_I = V_{CC}-2.1V$ |
| | | | | mA | TDI/TMS Pin, |
| | | | | | Test One with the Other Floating |

⁽¹⁾ Maximum test duration 2.0 ms, one output loaded at a time.

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Noise Specifications

| Symbol | Parameter | V _{CC} | Military | Units | Fig. |
|------------------------|--------------|-----------------|--|-------|------|
| | | (V) | (V) $T_A = -55^{\circ}C \text{ to } +125^{\circ}C$ | | No. |
| | | | Guaranteed Limits | | |
| V _{OLP} | Maximum High | 5.0 | 0.8 | V | |
| | Output Noise | | | | |
| (1)(2) _{VOLV} | Minimum Low | 5.0 | -0.8 | V | |
| | Output Noise | | | | |
| | (1) (2) | | | | |

Maximum number of outputs that can switch simultaneously is n. (n-1) outputs are switched LOW and one output held LOW. Maximum number of outputs that can switch simultaneously is n. (n-1) outputs are switched HIGH and one output held HIGH. (2)



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AC Electrical Characteristics

Normal Operation

| Symbol | Parameter | V _{cc} | Military T _A = -55°C to +125°C C _L = 50 pF | | Units | Fig. No. |
|--------------------|-------------------|---------------------|---|------|-------|-------------|
| | | V _{CC} (V) | | | | |
| | | | | | | |
| | | | | | | |
| | | | Min | Max | | |
| t _{PLH} , | Propagation Delay | 5.0 | 2.5 | 10.5 | ns | |
| t _{PHL} | Data to Q | | 2.5 | 10.5 | | |
| t _{PLZ} , | Disable Time | 5.0 | 1.5 | 11.2 | ns | |
| t _{PHZ} | | | 1.5 | 11.2 | | |
| t _{PZL} , | Enable Time | 5.0 | 2.0 | 14.0 | ns | |
| t _{PZH} | | | 2.0 | 12.0 | | |

⁽¹⁾ Voltage Range 5.0 is $5.0V \pm 0.5V$.

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AC Electrical Characteristics

Scan Test Operation

| Symbol | Parameter | V _{CC} | Mil | itary | Units | Fig. |
|--------------------|------------------------|------------------------|------------------------|-------|-------|------|
| | | V _{CC} (V) | T, | A = | | No. |
| | | −55°C to +125°C | | | | |
| | | | C _L = 50 pF | | | |
| | | | Min | Max | | |
| t _{PLH} , | Propagation Delay | 5.0 | 3.5 | 15.8 | ns | |
| t _{PHL} | TCK to TDO | | 3.5 | 15.8 | | |
| t _{PLZ} , | Disable Time | 5.0 | 2.5 | 13.2 | ns | |
| t _{PHZ} | TCK to TDO | | 2.5 | 13.2 | | |
| t _{PZL} , | Enable Time | 5.0 | 3.0 | 17.0 | ns | |
| t _{PZH} | TCK to TDO | | 3.0 | 17.0 | | |
| t _{PLH} , | Propagation Delay | | 5.0 | 21.7 | | |
| t _{PHL} | TCK to Data Out | 5.0 | 5.0 | 21.7 | ns | |
| | During Update-DR State | | | | | |
| t _{PLH} , | Propagation Delay | | 5.0 | 21.2 | | |
| t _{PHL} | TCK to Data Out | 5.0 | 5.0 | 21.2 | ns | |
| | During Update-IR State | | | | | |
| t _{PLH} , | Propagation Delay | | | | | |
| t _{PHL} | TCK to Data Out | 5.0 | 5.5 | 23.0 | ns | |
| | During Test Logic | | 5.5 | 23.0 | | |
| | Reset State | | | | | |
| t_{PLZ} , | Propagation Delay | | 4.0 | 19.6 | | |
| t _{PHZ} | TCK to Data Out | 5.0 | 4.0 | 19.6 | ns | |
| | During Update-DR State | | | | | |
| t _{PLZ} , | Propagation Delay | | 5.0 | 22.4 | | |
| t _{PHZ} | TCK to Data Out | 5.0 | 5.0 | 22.4 | ns | |
| | During Update-IR State | | | | | |
| t _{PLZ} , | Propagation Delay | | | | | |
| t _{PHZ} | TCK to Data Out | 5.0 | 5.0 | 23.3 | ns | |
| | During Test Logic | | 5.0 | 23.3 | | |
| | Reset State | | | | | |
| t _{PZL} , | Propagation Delay | | 5.0 | 22.6 | | |
| t _{PZH} | TCK to Data Out | 5.0 | 5.0 | 22.6 | ns | |
| | During Update-DR State | | | | | |
| t _{PZL} , | Propagation Delay | | 6.5 | 26.2 | | |
| t _{PZH} | TCK to Data Out | 5.0 | 6.5 | 26.2 | ns | |
| | During Update-IR State | | | | | |
| PZL, | Propagation Delay | | | | | |
| [‡] PZH | TCK to Data Out | 5.0 | 7.0 | 27.4 | ns | |
| | During Test Logic | | 7.0 | 27.4 | | |
| | Reset State | | | | | |

⁽¹⁾ Voltage Range 5.0 is $5.0V \pm 0.5V$.



AC Operating Requirements

Scan Test Operation

| Symbol | Parameter | V _{CC} (V) | Military | Units | Fig. No. |
|------------------|-------------------------------------|------------------------|----------------------------------|-------|-------------|
| | | | T _A = −55°C to +125°C | | |
| | | | C _L = 50 pF | | |
| | | | Guaranteed Minimum | | |
| t _S | Setup Time, H or L | 5.0 | 3.0 | ns | |
| | Data to TCK (2) | | | | |
| t _H | Hold Time, H or L | 5.0 | 5.0 | ns | |
| | TCK to Data (2) | | | | |
| t _S | Setup Time, H or L | | | | |
| | AOE _n , BOE _n | 5.0 | 3.0 | ns | |
| | to TCK (3) | | | | |
| t _H | Hold Time, H or L | | | | |
| | TCK to \overline{AOE}_n , | 5.0 | 4.5 | ns | |
| | BOE _n (3) | | | | |
| t _S | Setup Time, H or L | | | | |
| | Internal AOE, BOE, | 5.0 | 3.0 | ns | |
| | to TCK (4) | | | | |
| t _H | Hold Time, H or L | | | | |
| | TCK to Internal | 5.0 | 3.0 | ns | |
| | AOE, BOE (4) | | | | |
| t _S | Setup Time, H or L | 5.0 | 8.0 | ns | |
| | TMS to TCK | | | | |
| t _H | Hold Time, H or L | 5.0 | 2.0 | ns | |
| | TCK to TMS | | | | |
| t _S | Setup Time, H or L | 5.0 | 4.0 | ns | |
| | TDI to TCK | | | | |
| t _H | Hold Time, H or L | 5.0 | 4.5 | ns | |
| | TCK to TDI | | | | |
| t _W | Pulse Width TCK | 5.0 | | | |
| | Н | | 12.0 | ns | |
| | L | | 5.0 | | |
| f _{max} | Maximum TCK | 5.0 | 25 | MHz | |
| | Clock Frequency | | | | |
| T _{PU} | Wait Time, Power Up | 5.0 | 100 | ns | |
| | to TCK | | | | |
| T _{DN} | Power Down Delay | 0.0 | 100 | ms | |

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 ⁽¹⁾ Voltage Range 5.0 is 5.0V ±0.5V.All Input Timing Delays involving TCK are measured from the rising edge of TCK.
 (2) This delay represents the timing relationship between the data input and TCK at the associated scan cells numbered 0-8, 9-17, 18-26

Timing pertains to BSR 37, 38, 40 and 41 only.

This delay represents the timing relationship between AOE/BOE and TCK for scan cells 36 and 39 only.





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Capacitance

| Symbol | Parameter | Max | Units | Conditions |
|------------------|------------------------|------|-------|------------------------|
| C _{IN} | Input Pin Capacitance | 5.0 | pF | $V_{CC} = 5.0V$ |
| C _{OUT} | Output Pin Capacitance | 15.0 | pF | $V_{CC} = 5.0V$ |
| C _{PD} | Power Dissipation | 35.0 | pF | V _{CC} = 5.0V |
| | Capacitance | | | |

IMPORTANT NOTICE

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